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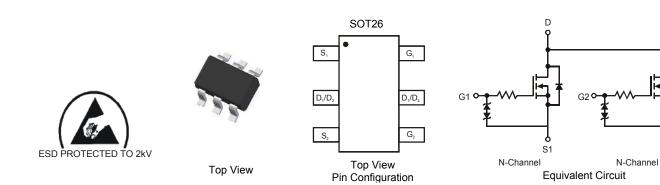
DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low Gate Charge
- Low R_{DS(ON)}:
 - 24mΩ @ V_{GS} = 4.5V
 - 28mΩ @ V_{GS} = 2.5V
 - 34mΩ @ V_{GS} = 1.8V
- Low Input/Output Leakage
- ESD Protected up to 2kV HBM
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT26
- Case Material Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.0008 grams (approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMG6968UDM-7	SOT26	3000/Tape & Reel

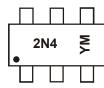
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



2N4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009) M = Month (ex: 9 = September)

Date Code Key

Year	2008		2009	2010		2011	2012		2013	2014		2015
Code	V		W	Х		Y	Z		А	В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	20	V
Gate-Source Voltage (Note 5)		V _{GSS}	±12	V
Drain Current (Note 6) Continuous	T _A = +25°C T _A = +70°C	ID	6.5 5.2	А
Pulsed Drain Current (Note 7)		I _{DM}	30	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	PD	0.85	W
Thermal Resistance, Junction to Ambient (Note 6) t ≤10s	$R_{ ext{ heta}JA}$	147	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

5. AEC-Q101 VGS maximum is $\pm 9.6V$. Notes:

6. Device mounted on 1"x1", FR-4 PC board with 2 oz. Copper and test pulse width t \leq 10s. 7. Repetitive Rating, pulse width limited by junction temperature.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
STATIC CHARACTERISTICS			•		•	·	
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	I _D = 250μA, V _{GS} = 0V	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 20V, V _{GS} = 0V	
Gate-Body Leakage Current	I _{GSS}	_	_	±10	μA	V_{DS} = 0V, V_{GS} = ±10V	
Gate-Source Breakdown Voltage	BV _{SGS}	±12	_	_	V	V_{DS} = 0V, I _G = ±250µA	
Gate Threshold Voltage	V _{GS(th)}	0.5	_	0.9	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance (Note 8)	R _{DS (ON)}		17 20 26	24 28 34	mΩ	V_{GS} = 4.5V, I_D = 6.5A V_{GS} = 2.5V, I_D = 5.5A V_{GS} = 1.8V, I_D = 3.5A	
Forward Transfer Admittance	Y _{FS}	—	8		S	V _{DS} = 10V, I _D = 5A	
Diode Forward Voltage (Note 8)	V _{SD}	—	0.7	1.0	V	I _S = 2.25A, V _{GS} = 0V	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	143	_	pF	V _{DS} = 10V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	C _{oss}	—	74		pF		
Reverse Transfer Capacitance	C _{rss}	—	29		pF		
Gate Resisitance	R _G	—	202		Ω	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz	
SWITCHING CHARACTERISTICS (Note 9)							
Total Gate Charge	Qg	_	8.8	_	nC		
Gate-Source Charge	Q _{gs}	_	1.4	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V, I_D = 6.5A$	
Gate-Drain Charge	Q _{gd}	_	3.0	_	nC		
Turn-On Delay Time	t _{D(on)}	_	53	_	ns		
Turn-On Rise Time	tr	_	78	_	ns	V _{DD} = 10V, V _{GS} = 4.5V,	
Turn-Off Delay Time	t _{D(off)}		562		ns	$R_L = 10\Omega, R_G = 6\Omega$	
Turn-Off Fall Time	t _f		234		ns		

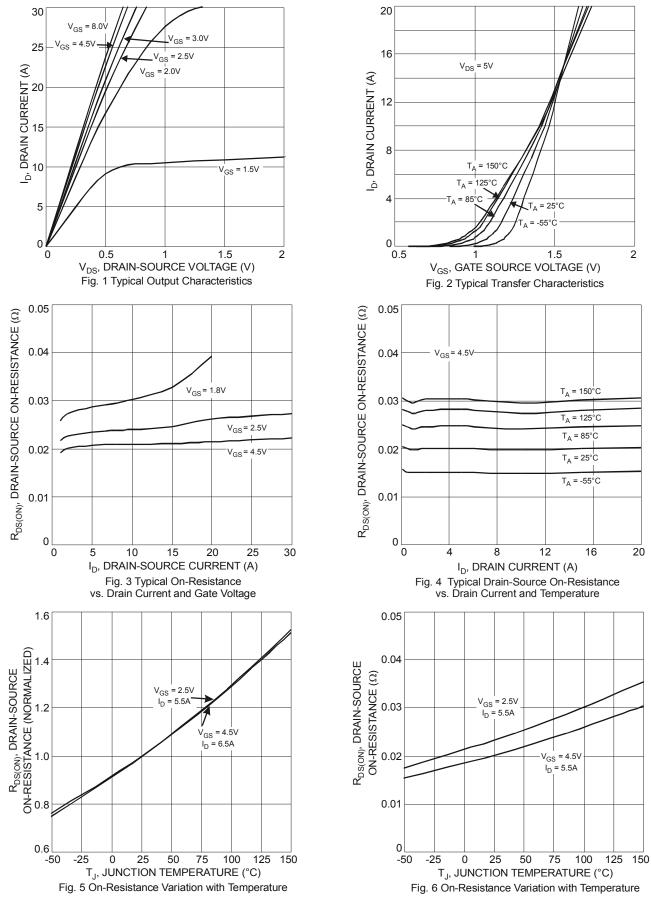
Notes: 8. Test pulse width t = 300ms.

9. Guaranteed by design. Not subject to production testing.



NEW PRODUCT

DMG6968UDM



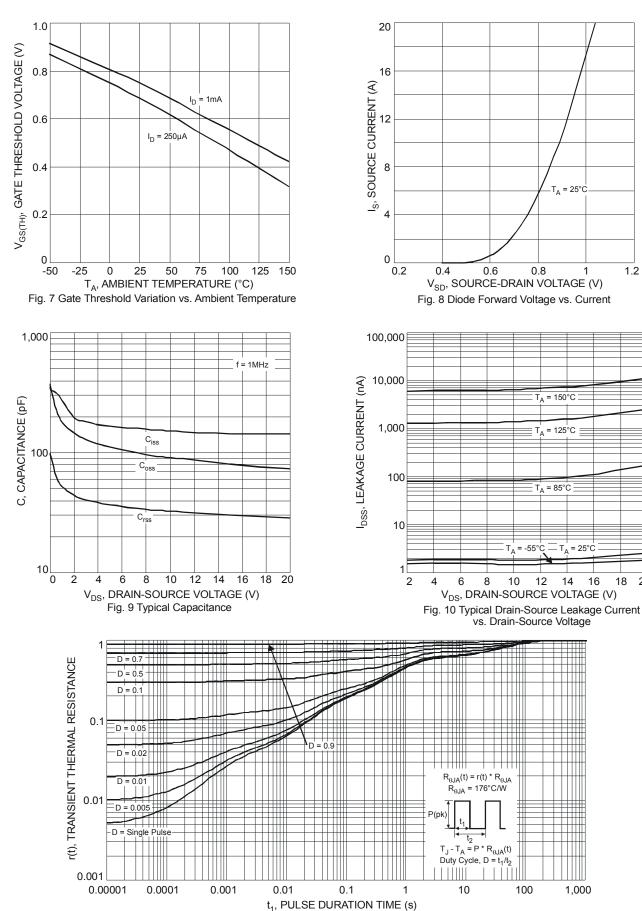
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DMG6968UDM Document number: DS31758 Rev. 5 - 2

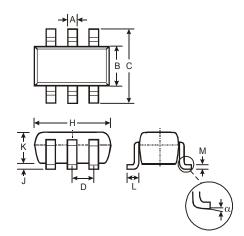
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Fig. 11 Transient Thermal Response



Package Outline Dimensions

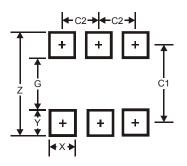
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT26						
Dim	Min	Max	Тур			
Α	0.35	0.50	0.38			
В	1.50	1.70	1.60			
С	2.70	3.00	2.80			
D	0.9					
Н	2.90	3.10	3.00			
J	0.013	0.10	0.05			
Κ	1.00 1.30 1.10					
L	L 0.35 0.55 0.40					
М	0.10	0.20	0.15			
α	α 0° 8° —					
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Y	0.80
C1	2.40
C2	0.95



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